UNISONIC TECHNOLOGIES CO., LTD

4N65-S Power MOSFET

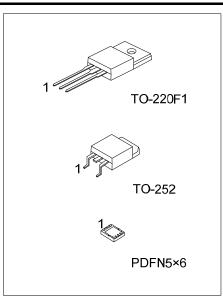
4.0A, 650V N-CHANNEL POWER MOSFET

DESCRIPTION

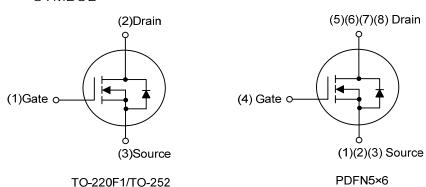
The UTC 4N65-S is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristic. This power MOSFET is usually used in high speed switching applications including power supplies, PWM motor controls, high efficient AC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)} \le 2.9 \Omega @ V_{GS} = 10V, I_D = 2.0A$
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness



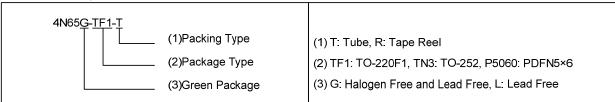
SYMBOL



ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment							Dooking	
Lead Free	Halogen Free	Package		2	3	4	5	6	7	8	Packing
4N65L-TF1-T	4N65G-TF1-T	TO-220F1	G	ם	S	•	-	•	-	-	Tube
4N65L-TN3-T	4N65G-TN3-T	TO-252	G	D	S	-	-	-	•	-	Tape Reel
4N65L-P5060-R	4N65G-P5060-R	PDFN5×6	S	S	S	G	D	D	D	D	Tape Reel

Pin Assignment: G: Gate Note: D: Drain S: Source



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MARKING



4N65-S Power MOSFET

■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	650	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I_{D}	4.0	Α
	Pulsed (Note2)	I_{DM}	16	Α
Avalanche Energy	Single Pulsed (Note3)	E _{AS}	150	mJ
Peak Diode Recovery dv/dt (Note4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220F1		36	W
	TO-252	P_D	50	W
	PDFN5×6		30	W
Junction Temperature		T_J	+150	°C
Operating Temperature		T _{OPR}	-55 ~ +150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

- Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

 Absolute maximum ratings are stress ratings only and functional device operation is not implied.
 - 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
 - 3. L = 18.75mH, I_{AS} = 4A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
 - 4. I_{SD} ≤4A, di/dt ≤200A/ μ s, V_{DD} ≤B V_{DSS} , Starting T_J = 25°C

■ THERMAL DATA

PARAMETER	PACKAGE	SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F1		62.5	°C/W
	TO-252	θ_{JA}	110	°C/W
	PDFN5×6		75 (Note)	°C/W
Junction to Case	TO-220F1		3.47	°C/W
	TO-252	θ_{JC}	2.5	°C/W
	PDFN5×6		4.17 (Note)	°C/W

Note: Note: The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

■ ELECTRICAL CHARACTERISTICS (T_C =25°C, unless otherwise specified)

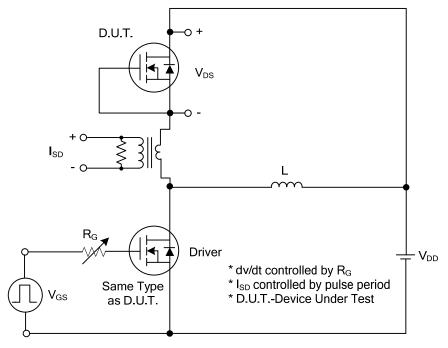
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	650			V		
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 650 V, V _{GS} = 0 V			10	μΑ		
Gate-Source Leakage Current	Forward	_	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA		
	Reverse	I_{GSS}	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA		
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_{J}$	I _D =250μA, Referenced to 25°C		0.6		V/°C		
ON CHARACTERISTICS									
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V		
Static Drain-Source On-State Re	esistance	R _{DS(ON)}	$V_{GS} = 10 \text{ V}, I_D = 2.0 \text{A}$			2.9	Ω		
DYNAMIC CHARACTERISTICS									
Input Capacitance		C _{ISS}	V - 25 V V - 0V		420	550	pF		
Output Capacitance		C _{OSS}	V _{DS} = 25 V, V _{GS} = 0V, If = 1MHz		40	60	pF		
Reverse Transfer Capacitance		C_{RSS}	I - IIVIMZ		4	8	pF		
SWITCHING CHARACTERISTICS10									
Total Gate Charge		Q_G	V = 50 V I = 1 3 A		15	20	nC		
Gate-Source Charge		Q_GS	V _{DS} = 50 V,I _D = 1.3 A, V _{GS} = 10V (Note 1, 2)		5		nC		
Gate-Drain Charge		Q_GD	VGS- 10V (Note 1, 2)		2		nC		
Turn-On Delay Time		t _{D(ON)}			60		ns		
Turn-On Rise Time		t _R	$V_{DS} = 30 \text{ V}, I_{D} = 0.5 \text{ A},$		25		ns		
Turn-Off Delay Time		$t_{D(OFF)}$	$R_G = 25\Omega$ (Note 1, 2)		125		ns		
Turn-Off Fall Time		t _F			30		ns		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS									
Maximum Continuous Drain-Sou	ırce	I-				4	Α		
Diode Forward Current		I _S				4	٨		
Maximum Pulsed Drain-Source Diode		I _{SM}				16	Α		
Forward Current		ISM				10	^		
Drain-Source Diode Forward Vo	ltage	V_{SD}	$V_{GS} = 0 V, I_S = 4A$			1.4	V		

Note: 1. Pulse Test: Pulse width≤300µs, Duty cycle≤2%.

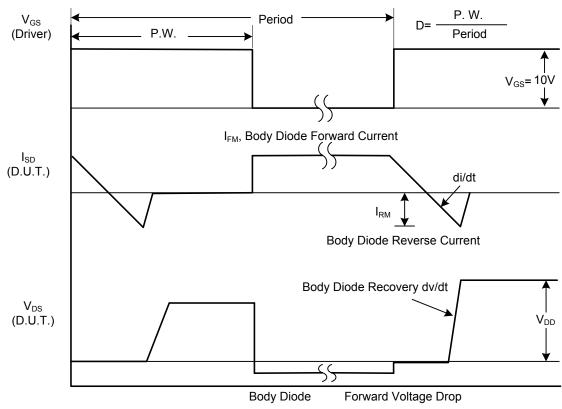
Power MOSFET

^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



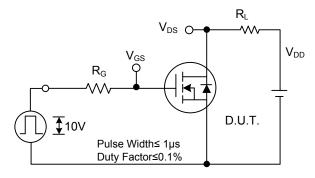
Peak Diode Recovery dv/dt Test Circuit



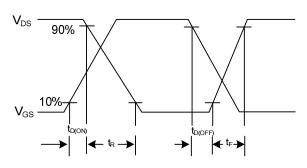
Peak Diode Recovery dv/dt Waveforms

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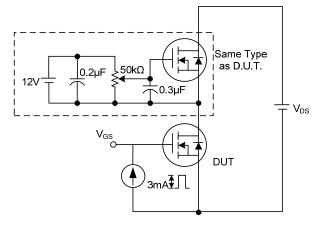
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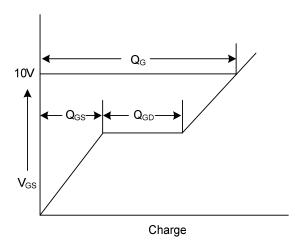
Switching Test Circuit



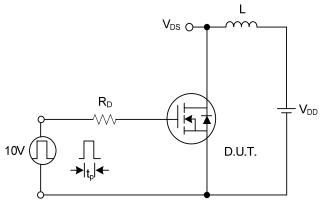
Switching Waveforms



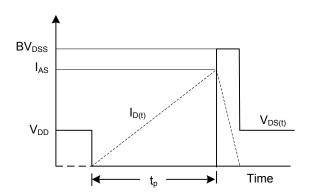
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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